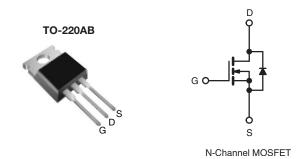


Power MOSFET

| PRODUCT SUMMARY | | | | |
|----------------------------|------------------------|-------|--|--|
| V _{DS} (V) | 100 | | | |
| $R_{DS(on)}(\Omega)$ | V _{GS} = 10 V | 0.077 | | |
| Q _g (Max.) (nC) | 72 | | | |
| Q _{gs} (nC) | 11 | | | |
| Q _{gd} (nC) | 32 | | | |
| Configuration | Single | | | |



FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- 175 °C Operating Temperature
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

| ORDERING INFORMATION | | | |
|----------------------|------------|--|--|
| Package | TO-220AB | | |
| Lead (Pb)-free | IRF540PbF | | |
| Lead (FD)-life | SiHF540-E3 | | |
| SnPb | IRF540 | | |
| SIFD | SiHF540 | | |

| ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted) | | | | | | |
|--|------------------|---|-----------------------------------|------------------|----------|--|
| PARAMETER | | | SYMBOL | LIMIT | UNIT | |
| Drain-Source Voltage | | | V _{DS} | 100 | M | |
| Gate-Source Voltage | | | V_{GS} | ± 20 | V | |
| Ocalia de Brais Ocasal | | $T_{\rm C} = 25 ^{\circ}{\rm C}$ $T_{\rm C} = 100 ^{\circ}{\rm C}$ | | 28 | | |
| Continuous Drain Current | VGS at 10 V | T _C = 100 °C | I _D | 20 | Α | |
| Pulsed Drain Current ^a | | | I _{DM} | 110 | | |
| Linear Derating Factor | | | | 1.0 | W/°C | |
| Single Pulse Avalanche Energy ^b | | | E _{AS} | 230 | mJ | |
| Repetitive Avalanche Current ^a | | | I _{AR} | 28 | Α | |
| Repetitive Avalanche Energy ^a | | | E _{AR} | 15 | mJ | |
| Maximum Power Dissipation $T_C = 25 ^{\circ}C$ | | | P_{D} | 150 | W | |
| Peak Diode Recovery dV/dt ^c | | | dV/dt | 5.5 | V/ns | |
| Operating Junction and Storage Temperature Range | | | T _J , T _{stg} | - 55 to + 175 | °C | |
| Soldering Recommendations (Peak Temperature) | for | 10 s | | 300 ^d | | |
| Mounting Torque | 6-32 or M3 screw | | | 10 | lbf ⋅ in | |
| Mounting Torque | | | | 1.1 | N · m | |

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. $V_{DD} = 25 \text{ V}$, starting $T_J = 25 \,^{\circ}\text{C}$, $L = 440 \,\mu\text{H}$, $R_g = 25 \,\Omega$, $I_{AS} = 28 \,\text{A}$ (see fig. 12).
- c. $I_{SD} \le 28$ A, $dI/dt \le 170$ A/ μ s, $V_{DD} \le V_{DS}$, $T_J \le 175$ °C.
- d. 1.6 mm from case.

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply



| THERMAL RESISTANCE RATINGS | | | | | |
|-------------------------------------|-------------------|------|------|------|--|
| PARAMETER | SYMBOL | TYP. | MAX. | UNIT | |
| Maximum Junction-to-Ambient | R _{thJA} | - | 62 | | |
| Case-to-Sink, Flat, Greased Surface | R _{thCS} | 0.50 | - | °C/W | |
| Maximum Junction-to-Case (Drain) | R _{thJC} | - | 1.0 | | |

| PARAMETER | SYMBOL | TEST (| TEST CONDITIONS | | | MAX. | UNIT |
|---|-----------------------|--|---|-----------|-----------|----------------------|------------------|
| Static | | | | | | • | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS} = 0$ |) V, I _D = 250 μA | 100 | - | - | V |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | Reference | to 25 °C, I _D = 1 mA | - | 0.13 | - | V/°C |
| Gate-Source Threshold Voltage | V _{GS(th)} | $V_{DS} = V$ | ' _{GS} , I _D = 250 μA | 2.0 | = | 4.0 | ٧ |
| Gate-Source Leakage | I _{GSS} | VG | _{aS} = ± 20 V | 1 | - | ± 100 | nA |
| Zero Gate Voltage Drain Current | less | V _{DS} = 100 V, V _{GS} = 0 V | | 1 | - | 25 | |
| Zero Gate Voltage Drain Current | I _{DSS} | $V_{DS} = 80 \text{ V}, \text{ V}$ | _{'GS} = 0 V, T _J = 150 °C | - | - | 250 | μA |
| Drain-Source On-State Resistance | R _{DS(on)} | V _{GS} = 10 V | I _D = 17 A ^b | 1 | - | 0.077 | Ω |
| Forward Transconductance | 9 _{fs} | $V_{DS} = \xi$ | $50 \text{ V}, I_D = 17 \text{ A}^b$ | 8.7 | - | - | S |
| Dynamic | | | | | | | |
| Input Capacitance | C _{iss} | V | $t'_{GS} = 0 \text{ V},$ | ı | 1700 | - | |
| Output Capacitance | C _{oss} | V | _{DS} = 25 V, | - | 560 | - | pF |
| Reverse Transfer Capacitance | C_{rss} | f = 1.0 MHz, see fig. 5 | | - | 120 | - | 1 |
| Total Gate Charge | Q_g | | | - | - | 72 | |
| Gate-Source Charge | Q _{gs} | V _{GS} = 10 V | $I_D = 17 \text{ A}, V_{DS} = 80 \text{ V},$ | - | - | 11 nC | nC |
| Gate-Drain Charge | Q _{gd} | | see fig. 6 and 13 ^b | | - | 32 | 1 |
| Turn-On Delay Time | t _{d(on)} | V_{DD} = 50 V, I_{D} = 17 A R_{g} = 9.1 Ω , R_{D} = 2.9 Ω , see fig. 10 ^b | | - | 11 | - | ns ns |
| Rise Time | t _r | | | - | 44 | - | |
| Turn-Off Delay Time | t _{d(off)} | | | - | 53 | - | |
| Fall Time | t _f | | | - | 43 | - | |
| Internal Drain Inductance | L_D | Between lead, 6 mm (0.25") fro | Between lead, 6 mm (0.25") from | | 4.5 | - | -11 |
| Internal Source Inductance | L _S | package and center of die contact | | - | 7.5 | - | - nH |
| Drain-Source Body Diode Characteristic | s | | | | | • | |
| Continuous Source-Drain Diode Current | I _S | showing the | / \ | | - | 28 | _ |
| Pulsed Diode Forward Current ^a | I _{SM} | integral reverse p - n junction diode | | - | - | 110 | A |
| Body Diode Voltage | V_{SD} | T _J = 25 °C, I _S = 28 A, V _{GS} = 0 V ^b | | - | - | 2.5 | V |
| Body Diode Reverse Recovery Time | t _{rr} | T _J = 25 °C, I _F = 17 A, dl/dt = 100 A/μs ^b | | - | 180 | 360 | ns |
| Body Diode Reverse Recovery Charge | Q _{rr} | | | - | 1.3 | 2.8 | μC |
| Forward Turn-On Time | t _{on} | Intrinsic turn- | on time is negligible (turn | -on is do | minated b | y L _S and | L _D) |

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width \leq 300 µs; duty cycle \leq 2 %.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

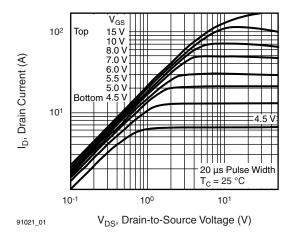


Fig. 1 - Typical Output Characteristics, $T_C = 25$ °C

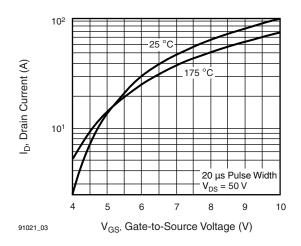


Fig. 3 - Typical Transfer Characteristics

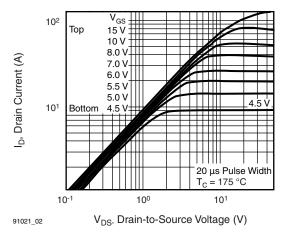


Fig. 2 - Typical Output Characteristics, T_C = 175 °C

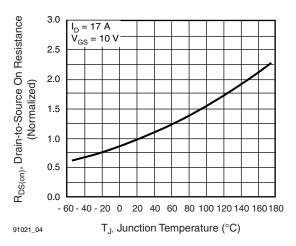
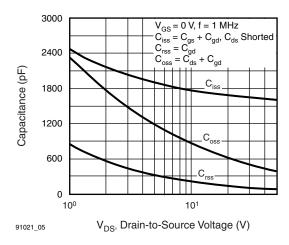


Fig. 4 - Normalized On-Resistance vs. Temperature







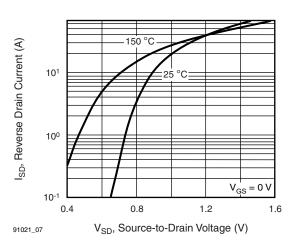


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

Fig. 7 - Typical Source-Drain Diode Forward Voltage

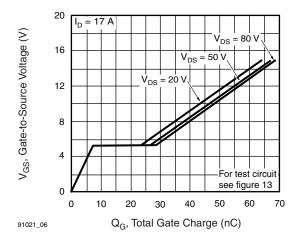


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

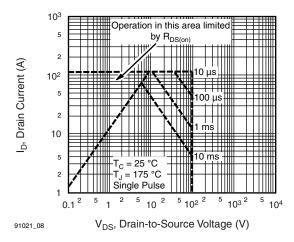
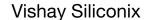


Fig. 8 - Maximum Safe Operating Area





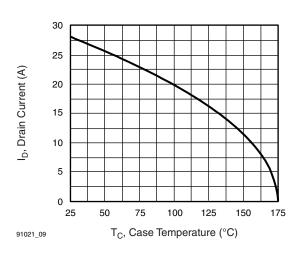


Fig. 9 - Maximum Drain Current vs. Case Temperature

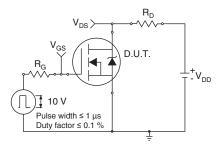


Fig. 10a - Switching Time Test Circuit

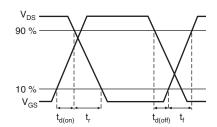


Fig. 10b - Switching Time Waveforms

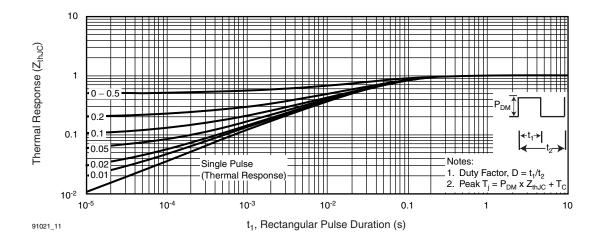


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



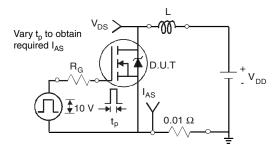


Fig. 12a - Unclamped Inductive Test Circuit

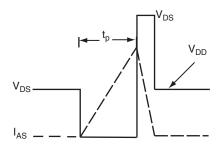


Fig. 12b - Unclamped Inductive Waveforms

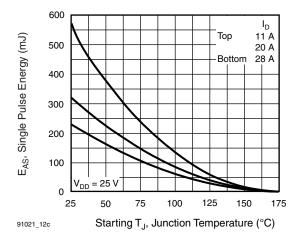


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

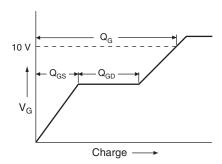


Fig. 13a - Basic Gate Charge Waveform

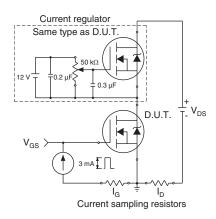
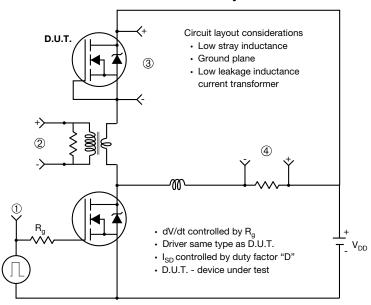


Fig. 13b - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



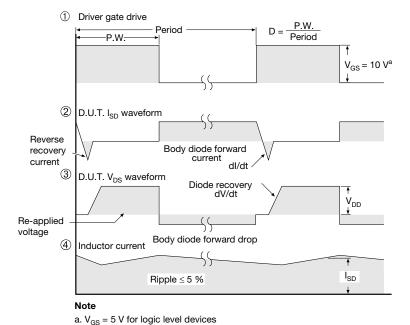


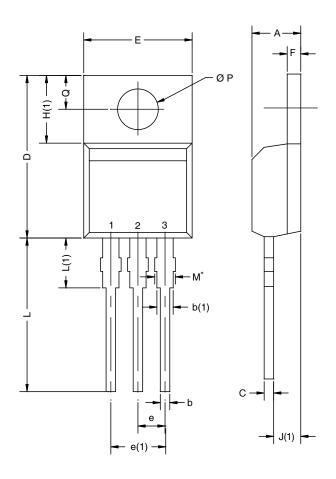
Fig. 14 - For N-Channel

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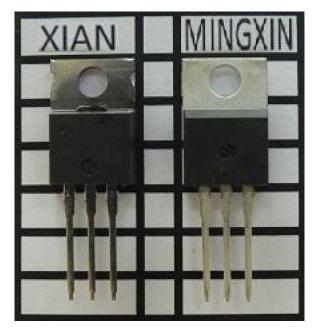
TO-220AB



| | MILLIM | IETERS | INCHES | | | |
|--|--------|--------|--------|-------|--|--|
| DIM. | MIN. | MAX. | MIN. | MAX. | | |
| Α | 4.25 | 4.65 | 0.167 | 0.183 | | |
| b | 0.69 | 1.01 | 0.027 | 0.040 | | |
| b(1) | 1.20 | 1.73 | 0.047 | 0.068 | | |
| С | 0.36 | 0.61 | 0.014 | 0.024 | | |
| D | 14.85 | 15.49 | 0.585 | 0.610 | | |
| E | 10.04 | 10.51 | 0.395 | 0.414 | | |
| е | 2.41 | 2.67 | 0.095 | 0.105 | | |
| e(1) | 4.88 | 5.28 | 0.192 | 0.208 | | |
| F | 1.14 | 1.40 | 0.045 | 0.055 | | |
| H(1) | 6.09 | 6.48 | 0.240 | 0.255 | | |
| J(1) | 2.41 | 2.92 | 0.095 | 0.115 | | |
| L | 13.35 | 14.02 | 0.526 | 0.552 | | |
| L(1) | 3.32 | 3.82 | 0.131 | 0.150 | | |
| ØР | 3.54 | 3.94 | 0.139 | 0.155 | | |
| Q | 2.60 | 3.00 | 0.102 | 0.118 | | |
| ECN: X12-0208-Rev. N, 08-Oct-12 DWG: 5471 | | | | | | |

Notes

- * M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM
- Xi'an and Mingxin actual photo





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Vishay

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